

# HMC175MS8 / 175MS8E

v02.0705



## GaAs MMIC SMT DOUBLE-BALANCED MIXER, 1.7 - 4.5 GHz

### Typical Applications

The HMC175MS8 / HMC175MS8E is ideal for:

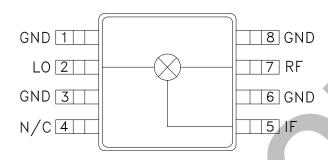
- Mini-Base Stations
- Portable Wireless
- PCMCIA

#### **Features**

Ultra Small Package: MSOP8

Conversion Loss: 8 dB LO / IF Isolation: 32 dB LO / RF Isolation: 30 dB Input IP3: +18 dBm

### **Functional Diagram**



#### **General Description**

The HMC175MS8 & HMC175MS8E are miniature double-balanced mixers in 8-lead plastic surface mount Mini Small Outline Packages (MSOP). The device can be used as an upconverter or downconverter. The mixer provides exceptional isolation and Intermodulation performance for applications in high signal density environments. This device can also be used as a biphase modulator or demodulator. The MSOP8 is the smallest footprint available for a complete double-balanced mixer (0.118" x 0.190" x 0.040").

# Electrical Specifications, $T_A = +25^{\circ}$ C, LO Drive = +13 dBm

Dominator	Broadband		PCS Band		ISM Band		I I a i A a			
Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range, RF & LO		1.7 - 4.5			1.7 - 2.0			2.2 - 2.6		GHz
Frequency Range, IF		DC - 1.0			DC - 1.0			DC - 1.0		GHz
Conversion Loss		8	11		9	11		8	10	dB
Noise Figure (SSB)		8	11		9	11		8	10	dB
LO to RF Isolation	25	30		35	40		30	35		dB
LO to IF Isolation	27	32		28	32		28	32		dB
IP3 (Input)	15	20		15	18		15	18		dBm
1 dB Gain Compression (Input)	9	12		9	11		9	11		dBm

**BALANCED MIXER, 1.7 - 4.5 GHz** 

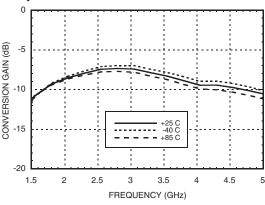
GaAs MMIC SMT DOUBLE-



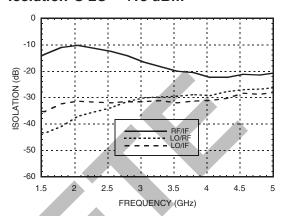
v02.0705



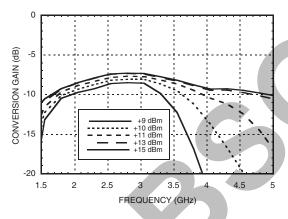
## Conversion Gain vs Temperature @ LO = +13 dBm



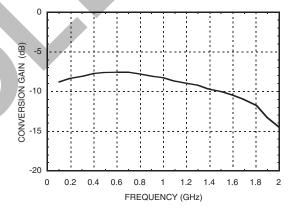
#### Isolation @ LO = +13 dBm



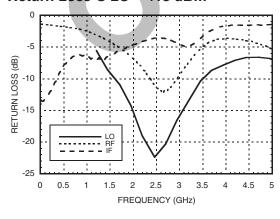
#### Conversion Gain vs LO Power



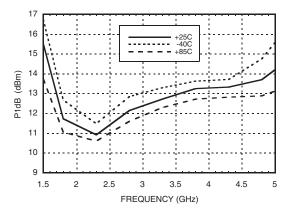
IF Bandwidth @ LO = +13 dBm



Return Loss @ LO = +13 dBm



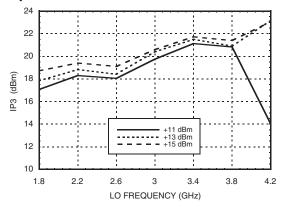
P1dB vs Temperature @ LO = +13 dBm



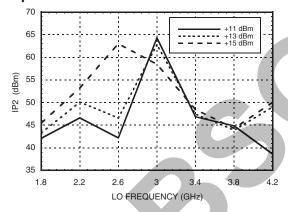




#### Input IP3 vs. LO Drive



#### Input IP2 vs. LO Drive

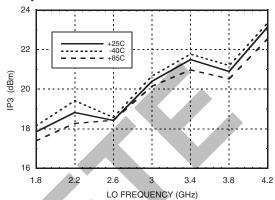


## **MxN Spurious Outputs**

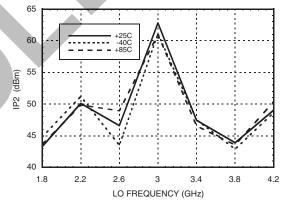
RF Frequency = 2.3 GHz @ -10 dBm					
LO Frequency = 2.4 GHz @ 13 dBm					
	nLO				
mRF	0	1	2	3	4
0	xx	1	12	12	37
1	4	0	27	39	38
2 74 53 56 60 67					
3	78	>105	73	72	79
4	>105	>105	>105	>105	>105
All values in dBc below IF power level.					

## GaAs MMIC SMT DOUBLE-BALANCED MIXER, 1.7 - 4.5 GHz

### Input IP3 vs. Temperature @ LO = +13 dBm



## Input IP2 vs. Temperature @ LO = +13 dBm



#### Harmonics of LO

LO	nLO Spur at RF Port				
Freq. (GHz)	1	2	3	4	
1.8	37	32	63	53	
2.2	35	30	37	63	
2.6	32	28	33	55	
3	30	29	53	52	
3.1	29	30	56	51	
3.6	29	39	52	53	
4.2	27	46	48	61	

LO = +13 dBm

Values in dBc below input LO level measured at RF Port.





## GaAs MMIC SMT DOUBLE-BALANCED MIXER, 1.7 - 4.5 GHz

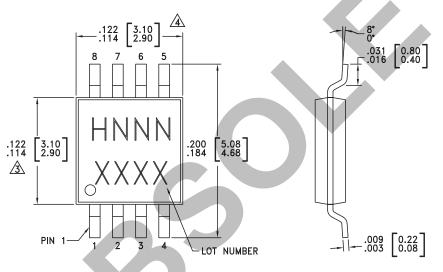
### **Absolute Maximum Ratings**

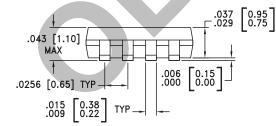
RF / IF Input	+13 dBm
LO Drive	+27 dBm
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

## **Outline Drawing**





#### NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
- 5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

## **Package Information**

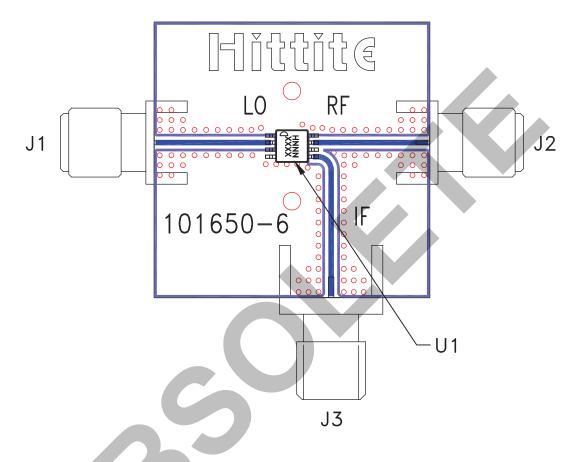
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC175MS8	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H175 XXXX
HMC175MS8E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	<u>H175</u> XXXX

- [1] Max peak reflow temperature of 235  $^{\circ}\text{C}$
- [2] Max peak reflow temperature of 260  $^{\circ}\text{C}$
- [3] 4-Digit lot number XXXX



GaAs MMIC SMT DOUBLE-BALANCED MIXER, 1.7 - 4.5 GHz

#### **Evaluation Circuit Board**



#### List of Materials for Evaluation PCB 103350 [1]

Item	Description
J1 - J3	PCB Mount SMA RF Connector
U1	HMC175MS8 / HMC175MS8E Mixer
PCB [2]	101650 Evaluation Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.





Notes:

# GaAs MMIC SMT DOUBLE-BALANCED MIXER, 1.7 - 4.5 GHz



# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for RF Mixer category:

Click to view products by Analog Devices manufacturer:

Other Similar products are found below:

 HMC337-SX
 HMC404-SX
 mamx-009646-23dbml
 HMC339-SX
 HMC8192-SX
 MIQ24MS-2
 HMC220BMS8GETR
 M85C
 HMC554A-SX

 HMC8192LG
 HMC521A-SX
 HMC521ACHIPS
 CMD258C4
 LT5511EFE
 MAMX-011023-SMB
 HMC399MS8TR
 HMC333TR

 HMC214MS8TR
 HMC175MS8TR
 MAMXSS0012TR-3000
 109728-HMC129LC4
 CSM1-13
 SA612AD/01.112
 HMC785LP4ETR

 LT5579IUH#PBF
 HMC773ALC3BTR
 HMC558ALC3B
 HMC329ALC3B
 MY63H
 AD8343ARUZ-REEL7
 AD608AR
 AD608AR

 AD831APZ
 AD831APZ-REEL7
 AD8342ACPZ-REEL7
 AD8343ARUZ
 AD8344ACPZ-REEL7
 ADL5350ACPZ-R7
 ADL5363ACPZ-R7

 ADL5365ACPZ-R7
 ADL5801ACPZ-R7
 ADL5802ACPZ-R7
 HMC1056LP4BE
 HMC1057-SX
 HMC1063LP3E
 HMC1093-SX
 HMC1106-SX

 SX
 HMC129
 HMC143
 HMC400MS8ETR